



Mini-Circuits

SURFACE MOUNT ^{top hat}

Directional Coupler

RDC-10-182-75X+

75Ω 10 dB 5 to 1800 MHz

THE BIG DEAL

- Low Mainline Loss, 1.7 dB Typ.
- Good Return Loss, 18 dB
- Excellent Coupling Flatness, ±0.2 dB
- Supports DOCSIS® 3.1/4.0 Systems

APPLICATIONS

- DOCSIS 3.1/4.0
- Cable TV



Generic photo used for illustration purposes only

CASE STYLE: TT2315

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

PRODUCT OVERVIEW

Mini-Circuits' RDC-10-182-75X+ surface-mount directional coupler provides 10 dB coupling with excellent flatness, low mainline loss, high directivity, and good return loss for 75Ω applications from 5 to 1800 MHz, supporting a variety of broadband applications including DOCSIS 3.1/4.0 systems and equipment. This model features core and wire construction with wrap-around terminations for good solderability and easy visual inspection.

KEY FEATURES

Feature	Advantages
Broadband, 5 to 1800 MHz	Supports bandwidth requirements for DOCSIS 3.1/4.0 systems and equipment.
Low Mainline Loss, 1.7 dB	Provides excellent through-path signal transmission and maintains low heat dissipation, avoiding the need for special heat sinking methods.
Power Handling, Up to 1 W	Usable in systems with a variety of signal power requirements.
Excellent Return Loss, 18 dB Typ.	Provides excellent matching for 75Ω systems.
Top Hat® Feature	Improves speed and accuracy of pick and place assembly.

REV. B
ECO-012267
RDC-10-182-75X+
MCL NY
260121





ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Condition (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		5		1800	MHz
Mainline Loss ¹	5-1250		1.3	1.8	dB
	1250-1800		1.9	2.8	
Nominal Coupling	5-1800		10±0.5		dB
Coupling Flatness(±)	5-1800		± 0.1	± 0.5	dB
Directivity	5-870	15	20		dB
	870-1250	14	20		
	1250-1800	10	15		
Return Loss (Input)	5-1800		18		dB
Return Loss (Output)	5-1800		20		dB
Return Loss (Coupled)	5-1800		18		dB
Input Power	5-1800			1.0	W

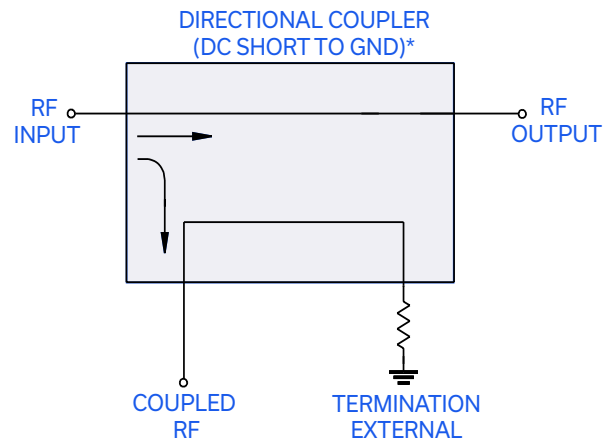
1. Mainline loss includes theoretical power loss at coupled port.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C

Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



*Electrical schematic is for Directional coupler with internal transformer(s) and external termination

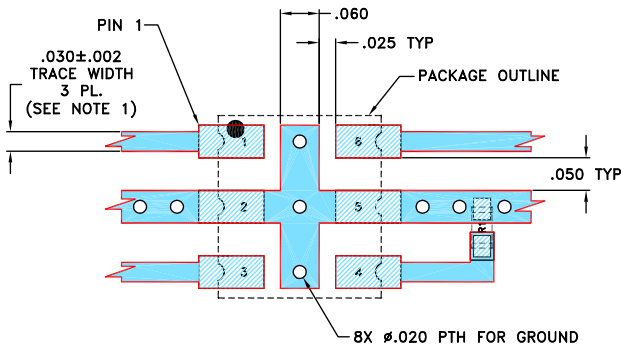


PIN CONNECTIONS

Function	Pad Number
INPUT	1
OUTPUT	6
COUPLED	3
GROUND	2
75Ω TERM EXTERNAL	4
No Internal Connection (Grounding Recommended)	5

PRODUCT MARKING: US

DEMO BOARD MCL P/N: TB-RDC1018275X+ SUGGESTED PCB LAYOUT (PL-452)

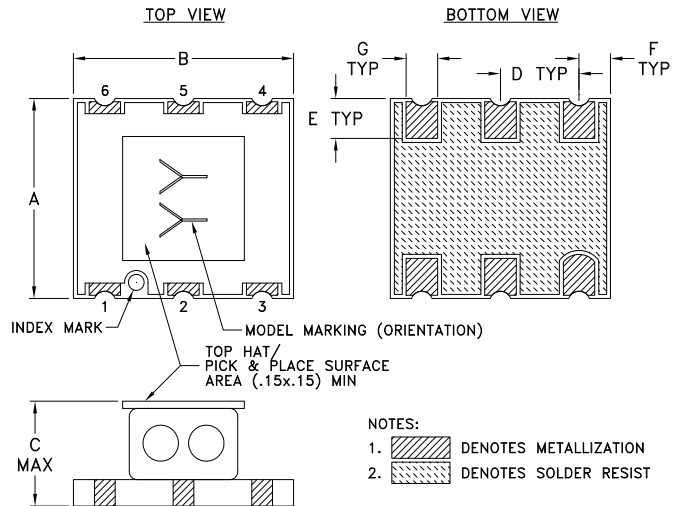


NOTES:

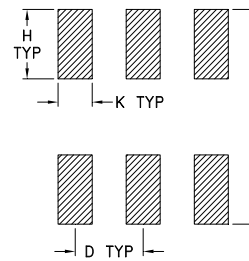
- TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- .0603 SIZE CHIP RESISTOR FOOT PRINT SHOWN FOR REFERENCE. FOR RESISTOR VALUE REFER TO TB-917+.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches mm)

A	B	C	D	E	F	G	H	J	K
.250	.280	.140	.100	.050	.040	.040	.100	.310	.050
6.35	7.11	3.56	2.54	1.27	1.02	1.02	2.54	7.87	1.27

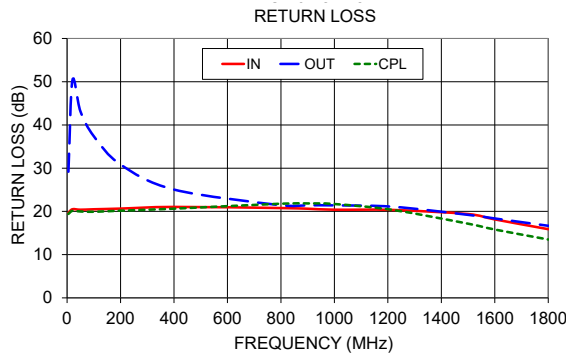
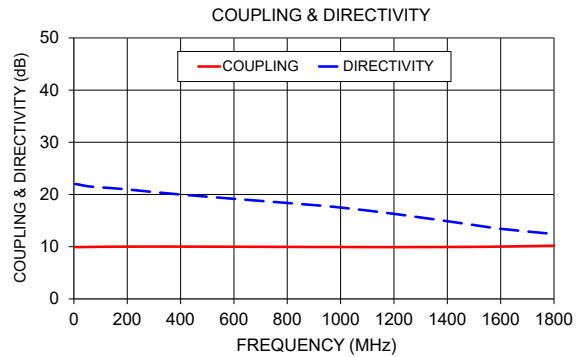
Weight: 0.35 grams

TAPE & REEL INFORMATION: F34



TYPICAL PERFORMANCE DATA

Frequency (MHz)	Mainline Loss (dB) In-Out	Coupling (dB) In-Cpl	Directivity (dB)	Return Loss (dB)		
				In	Out	Cpl
5	1.05	9.94	21.99	19.68	29.18	19.42
20	1.02	9.92	21.90	20.50	50.34	20.13
50	1.06	9.95	21.59	20.39	43.13	19.99
100	1.10	9.98	21.36	20.49	37.38	19.91
200	1.13	10.02	20.98	20.65	30.84	20.17
400	1.15	10.02	19.99	21.04	25.05	20.63
800	1.26	9.96	18.38	20.78	21.42	21.79
900	1.30	9.95	17.97	20.62	21.41	21.85
1000	1.33	9.94	17.50	20.39	21.40	21.71
1218	1.43	9.92	16.18	20.34	21.08	20.35
1500	1.63	9.97	14.15	19.39	19.20	17.16
1600	1.76	10.03	13.43	18.15	18.36	15.81
1800	2.05	10.19	12.43	15.89	16.67	13.50

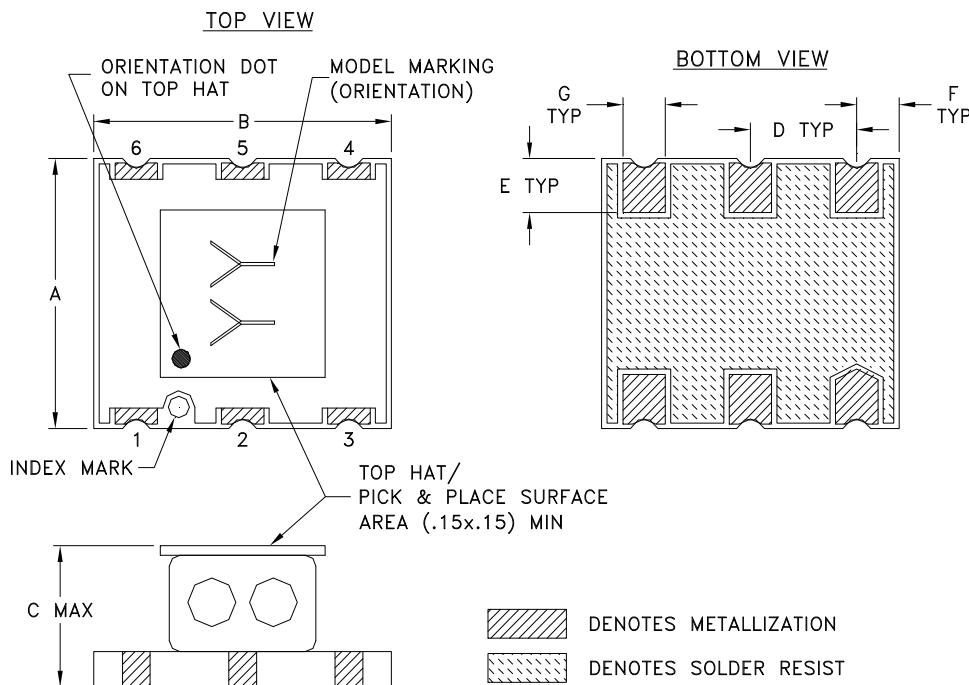


NOTES

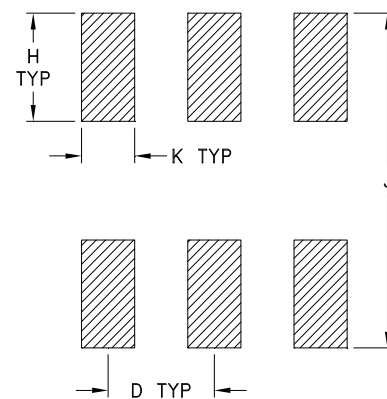
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Outline Dimensions

TT2315



PCB Land Pattern



SUGGESTED LAYOUT
TOLERANCE TO BE WITHIN ± 0.02

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
TT2315	.250 (6.35)	.280 (7.11)	.140 (3.56)	.100 (2.54)	.050 (1.27)	.040 (1.02)	.040 (1.02)	.100 (2.54)	.310 (7.87)	.050 (1.27)	.35

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, Base material: Printed wiring laminate.
- Termination finish: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate.
All models, (+) suffix.
- Top-Hat total thickness: .013 inches MAX.
- Orientation Dot on Top Hat & PCB corresponds to Pin #1.

Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



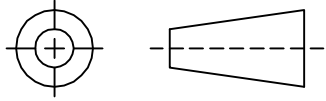
INTERNET <http://www.minicircuits.com>

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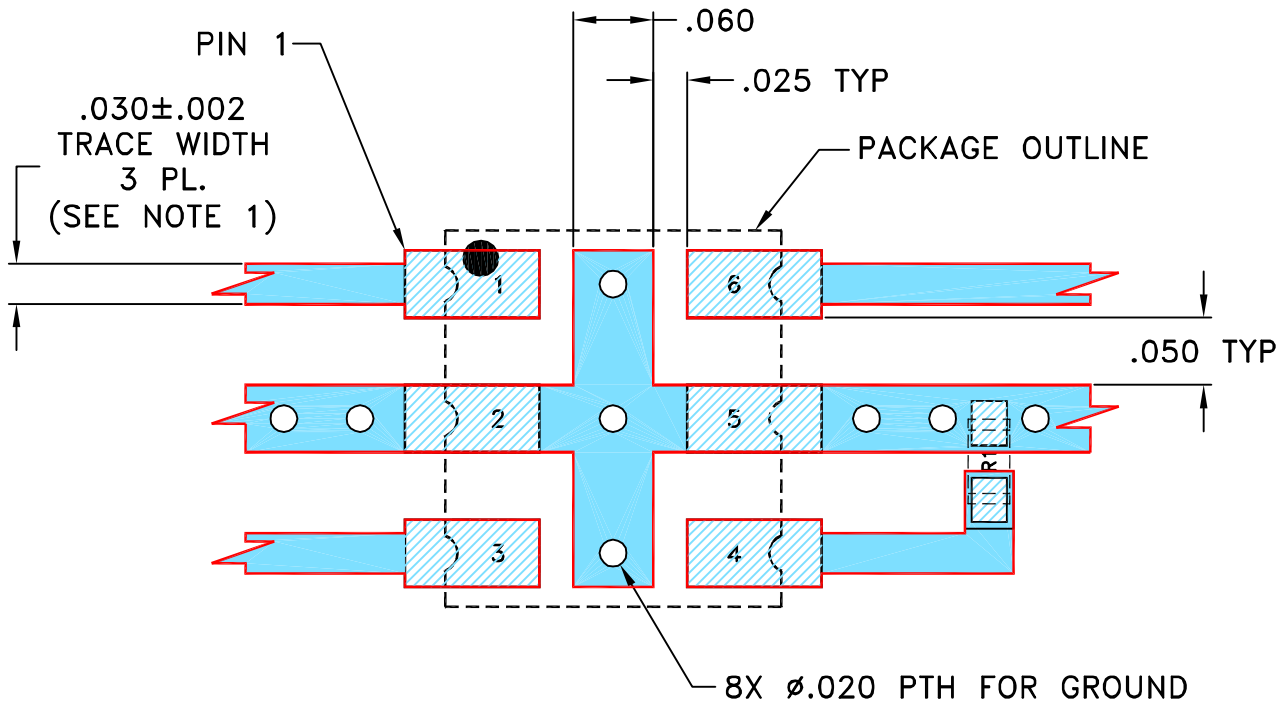
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M158078	NEW RELEASE	09/16/16	CA	IL

**SUGGESTED MOUNTING CONFIGURATION
FOR TT2315 CASE STYLE, "06DC03" PIN CODE**



NOTES:

1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. 0603 SIZE CHIP RESISTOR FOOT PRINT SHOWN FOR REFERENCE,
FOR RESISTOR VALUE REFER TO TB-917+.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	CA 09/15/16
	CHECKED	IL 09/16/16
	APPROVED	YL 09/16/16

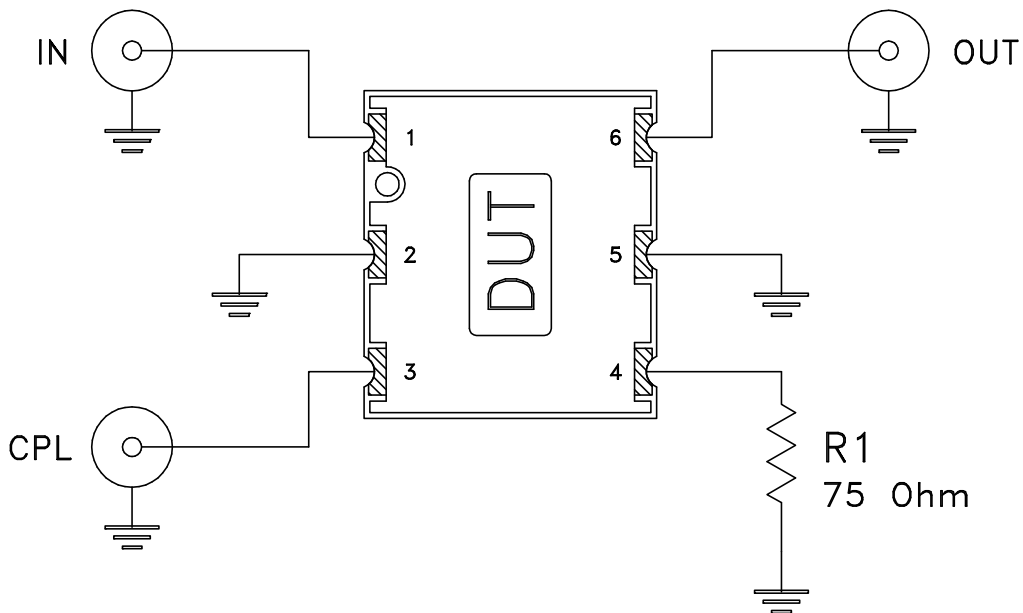
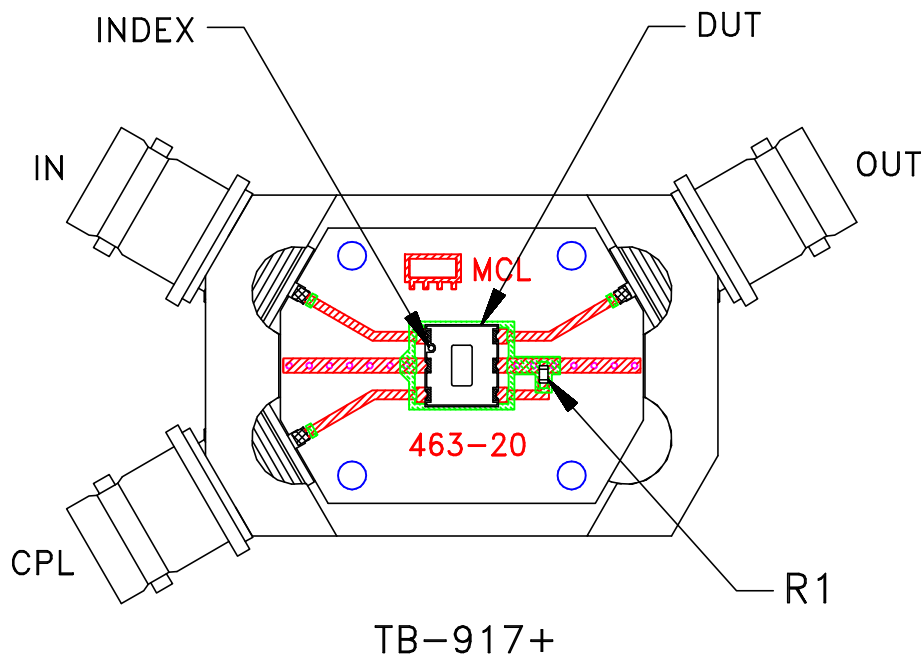
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Brooklyn NY 11235

PL, 06DC03, TT2315, TB-917+

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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-452	REV: OR
FILE: 98PL452	SCALE: 7:1	SHEET: 1 OF 1	

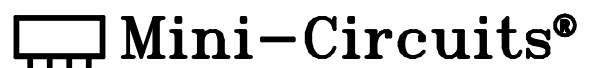
Evaluation Board and Circuit



Schematic Diagram

Notes:

1. 75 Ohm BNC connectors.
2. PCB Material: R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215